Tyrone Camarero Specifications

Camarero DS3007R-436RT

Key features

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/ v3 family
- Intel® C612 chipset
- Up to 2TB ECC 3DS LRDIMM, up to DDR4- 2400 MHz; 16x DIMM slots
- 1 PCI-E 3.0 x16, 6 PCI-E 3.0 x8 (slot 1 & 2 occupied by controller and JBOD expansion port)
- Dual 10GBase-T LAN w/ Intel® X540
- 36x 3.5" Hot-swap SAS3/SATA3 drive bays (24 front + 12 rear); 2x 2.5" optional Hot-swap drive bays (rear);4x 2.5" internal fixed drive bays
- SAS3 via LSI 3108 AOC (HW RAID
- Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 7x 80mm middle cooling fans
- 1280W Redundant Power Supplies Platinum Level (94%)









Processor/Cache

Processor Dual socket R3 (LGA 2011) supports Intel®

Xeon® processor E5-2600v4/ v3 family

Chipset

Chipset Intel® C612 chipset

System Memory

Memory Capacity 16x 288-pin DDR4 DIMM slots,Up to 2TB

ECC 3DS LRDIMM, 512GB ECC RDIMM

Expansion Slots

PCI-Express 1x PCI-E 3.0 x16 slot, 6x PCI-E 3.0 x8 slots,

Slot 1 & 2 occupied by controller and

JBOD Expansion Port

Integrated On-Board

SATA SATA3 (6Gbps) with RAID 0, 1, 5, 10

SAS SAS3 (12Gbps) via LSI 3108 AOC; HW RAID

LAN 2x RJ45 10GBase-T LAN ports, 1x RJ45

Dedicated IPMI LAN port

Add-on Options

Optical Drive None

Front Panel

LED Indicators Power status LED, Hard drive activity LED,

2x Network activity LEDs, System Overheat

LED, Power fail LED

Buttons Power On/Off button, System Reset button

Drive Bays

HDD bays 36x 3.5" Hot-swap SAS3/SATA3 drive bays,

Double-sided: 24 front + 12 rear drivebays

Optional 2x 2.5" Hot-swap HDD bays (rear),

Fixed internal Drive Bracket supports,

1x 3.5 or 2x 2.5" devices

Power Supply

1280W Redundant Power Supplies Platinum Level (94%)

Cooling System

7x 80mm middle cooling fans. Redundant cooling

Form Factor

Form Factor 4U Rackmount

Width: 17.2" (437 mm), Height: 7 (178mm) ' Depth: 27.5" (699mm)

Email: info@tyronesystems.com

For more/current product information, visit www.tyronesystems.com

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